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Contact us

Tel: +86-755-8981 8866 Fax: +86-755-8427 6832

Email & Skype: info@chipsmall.com Web: www.chipsmall.com

Address: A1208, Overseas Decoration Building, #122 Zhenhua RD., Futian, Shenzhen, China





BAS116GW

Low leakage switching diode

5 April 2018

Product data sheet

1. General description

Low leakage switching diode, encapsulated in an SOD123 small Surface-Mounted Device (SMD) plastic package.

2. Features and benefits

- High switching speed: $t_{rr} = 0.8 \mu\text{s}$
- Low leakage current: $I_R = 3 \text{ pA}$
- Repetitive peak reverse voltage $V_{RRM} \leq 85 \text{ V}$
- Low capacitance: $C_d = 2 \text{ pF}$
- Small SMD plastic package
- AEC-Q101 qualified

3. Applications

- Low-leakage current applications
- General-purpose switching



4. Quick reference data

Table 1. Quick reference data

Symbol	Parameter	Conditions	Min	Typ	Max	Unit
V_{RRM}	repetitive peak reverse voltage	$T_j = 25 \text{ }^\circ\text{C}$	-	-	85	V
I_F	forward current	$t_p \leq 300 \mu\text{s}; \delta \leq 0.02; T_{amb} = 25 \text{ }^\circ\text{C}$	-	-	215	mA
V_R	reverse voltage	$T_j = 25 \text{ }^\circ\text{C}$	-	-	75	V
V_F	forward voltage	$I_F = 150 \text{ mA}; t_p \leq 300 \mu\text{s}; \delta \leq 0.02; T_j = 25 \text{ }^\circ\text{C}$	-	-	1.25	V
I_R	reverse current	$V_R = 75 \text{ V}; \text{pulsed}; T_j = 25 \text{ }^\circ\text{C}$	-	0.003	5	nA
t_{rr}	reverse recovery time	$I_F = 10 \text{ mA}; I_R = 10 \text{ mA}; R_L = 100 \Omega; I_{R(\text{meas})} = 1 \text{ mA}; T_j = 25 \text{ }^\circ\text{C}$	-	0.8	3	μs

5. Pinning information

Table 2. Pinning information

Pin	Symbol	Description	Simplified outline	Graphic symbol
1	K	Cathode	 SOD123	 sym001
2	A	Anode		

6. Ordering information

Table 3. Ordering information

Type number	Package		
	Name	Description	Version
BAS116GW	SOD123	Plastic surface-mounted package; 2 leads	SOD123

7. Marking

Table 4. Marking codes

Type number	Marking code
BAS116GW	GB

8. Limiting values

Table 5. Limiting values

In accordance with the Absolute Maximum Rating System (IEC 60134).

Symbol	Parameter	Conditions		Min	Max	Unit
V_{RRM}	repetitive peak reverse voltage	$T_j = 25\text{ °C}$		-	85	V
V_R	reverse voltage			-	75	V
I_F	forward current	$t_p \leq 300\ \mu\text{s}$; $\delta \leq 0.02$; $T_{amb} = 25\text{ °C}$		-	215	mA
I_{FSM}	non-repetitive peak forward current	$t_p = 1\ \mu\text{s}$; $T_{j(\text{init})} = 25\text{ °C}$; square wave		-	4	A
		$t_p = 1\ \text{ms}$; $T_{j(\text{init})} = 25\text{ °C}$; square wave		-	1	A
		$t_p = 1\ \text{s}$; $T_{j(\text{init})} = 25\text{ °C}$; square wave		-	0.5	A
I_{FRM}	repetitive peak forward current			-	500	mA
P_{tot}	total power dissipation	$T_{amb} \leq 25\text{ °C}$	[1]	-	357	mW
			[2]	-	600	mW
Per device, one diode loaded						
T_j	junction temperature			-	150	°C
T_{amb}	ambient temperature			-55	150	°C
T_{stg}	storage temperature			-65	150	°C

[1] Device mounted on an FR4 Printed-Circuit Board (PCB), single-sided copper, tin-plated and standard footprint.

[2] Device mounted on an FR4 Printed-Circuit Board (PCB), single-sided copper, tin-plated mounting pad for cathode 1 cm^2 .

9. Thermal characteristics

Table 6. Thermal characteristics

Symbol	Parameter	Conditions		Min	Typ	Max	Unit
$R_{th(j-a)}$	thermal resistance from junction to ambient	In free air	[1]	-	-	350	K/W
			[2]	-	-	210	K/W
$R_{th(j-sp)}$	thermal resistance from junction to solder point		[3]	-	-	58	K/W

[1] Device mounted on an FR4 PCB, single-sided copper, tin-plated and standard footprint.

[2] Device mounted on an FR4 PCB, single-sided copper, tin-plated mounting pad for cathode 1 cm^2 .

[3] Soldering point of cathode tab.

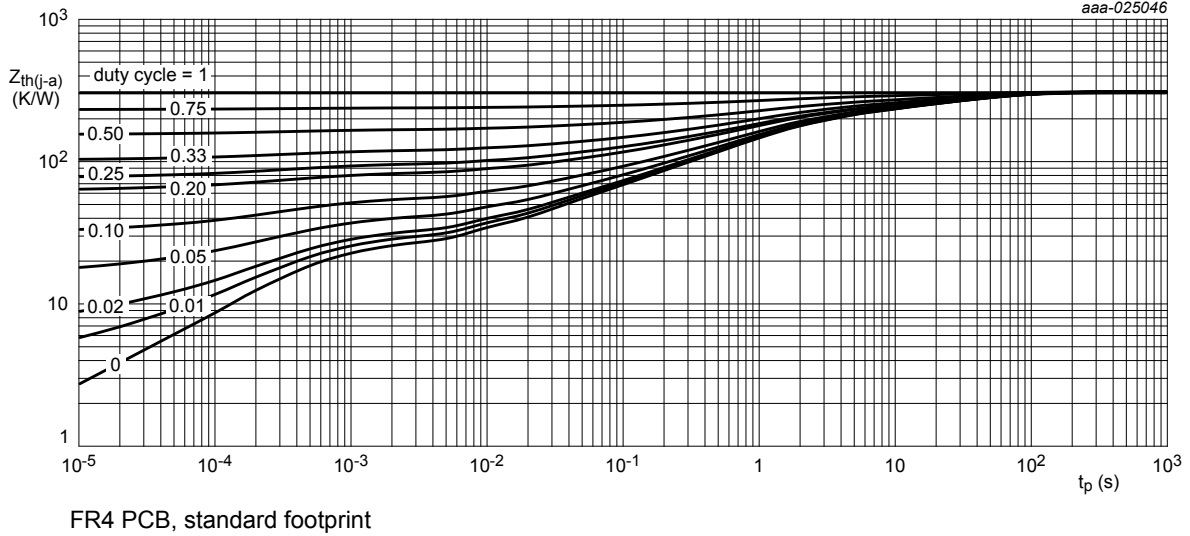


Fig. 1. Transient thermal impedance from junction to ambient as a function of pulse duration; typical values

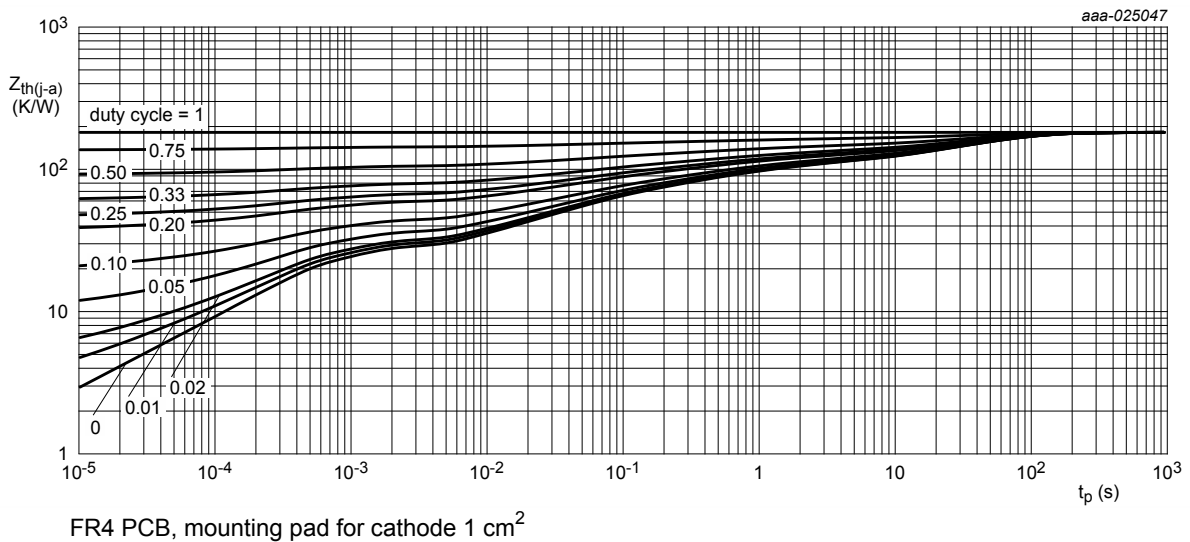
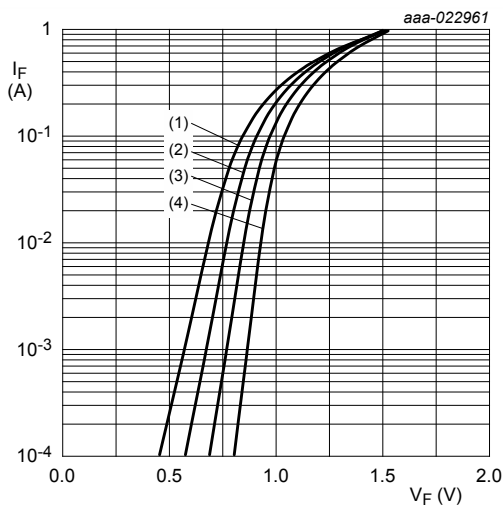


Fig. 2. Transient thermal impedance from junction to ambient as a function of pulse duration; typical values

10. Characteristics

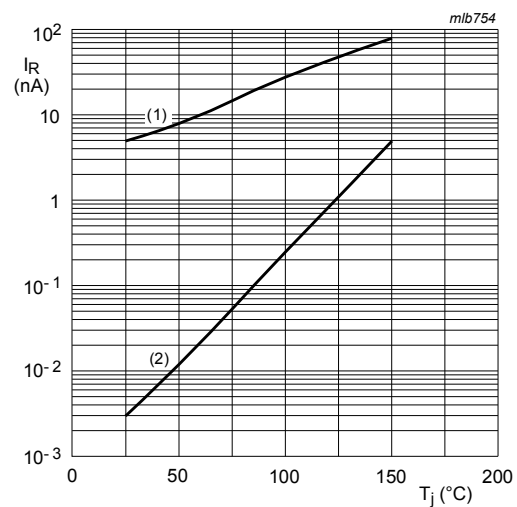
Table 7. Characteristics

Symbol	Parameter	Conditions	Min	Typ	Max	Unit
V_F	forward voltage	$I_F = 1 \text{ mA}; t_p \leq 300 \mu\text{s}; \delta \leq 0.02;$ $T_j = 25 \text{ }^\circ\text{C}$	-	-	0.9	V
		$I_F = 10 \text{ mA}; t_p \leq 300 \mu\text{s}; \delta \leq 0.02;$ $T_j = 25 \text{ }^\circ\text{C}$	-	-	1	V
		$I_F = 50 \text{ mA}; t_p \leq 300 \mu\text{s}; \delta \leq 0.02;$ $T_j = 25 \text{ }^\circ\text{C}$	-	-	1.1	V
		$I_F = 150 \text{ mA}; t_p \leq 300 \mu\text{s}; \delta \leq 0.02;$ $T_j = 25 \text{ }^\circ\text{C}$	-	-	1.25	V
I_R	reverse current	$V_R = 75 \text{ V}; \text{pulsed}; T_j = 25 \text{ }^\circ\text{C}$	-	0.003	5	nA
		$V_R = 75 \text{ V}; \text{pulsed}; T_j = 150 \text{ }^\circ\text{C}$	-	3	80	nA
C_d	diode capacitance	$V_R = 0 \text{ V}; f = 1 \text{ MHz}; T_j = 25 \text{ }^\circ\text{C}$	-	2	-	pF
t_{rr}	reverse recovery time	$I_F = 10 \text{ mA}; I_R = 10 \text{ mA}; R_L = 100 \Omega;$ $I_{R(\text{meas})} = 1 \text{ mA}; T_j = 25 \text{ }^\circ\text{C}$	-	0.8	3	μs



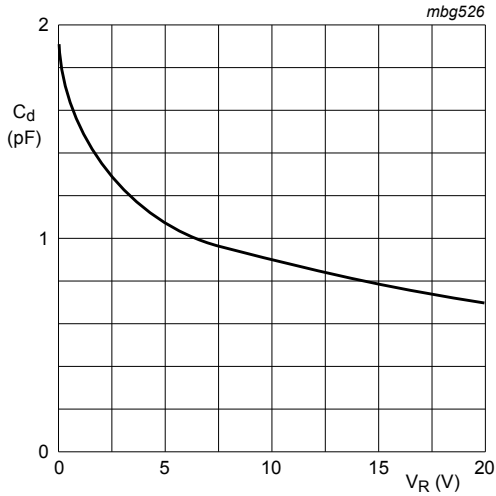
- (1) $T_j = 150 \text{ }^\circ\text{C}$
- (2) $T_j = 85 \text{ }^\circ\text{C}$
- (3) $T_j = 25 \text{ }^\circ\text{C}$
- (4) $T_j = -40 \text{ }^\circ\text{C}$

Fig. 3. Forward current as a function of forward voltage; typical values



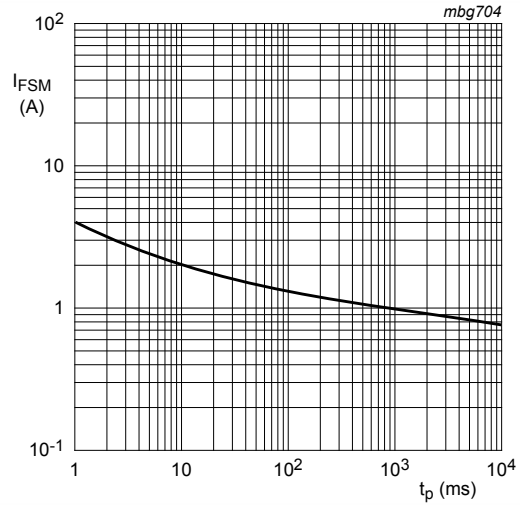
- $V_R = 75 \text{ V}$
- (1) Maximum values
- (2) Typical values

Fig. 4. Reverse current as a function of junction temperature



$f = 1 \text{ MHz}; T_{\text{amb}} = 25 \text{ }^\circ\text{C}$

Fig. 5. Diode capacitance as a function of reverse voltage; typical values

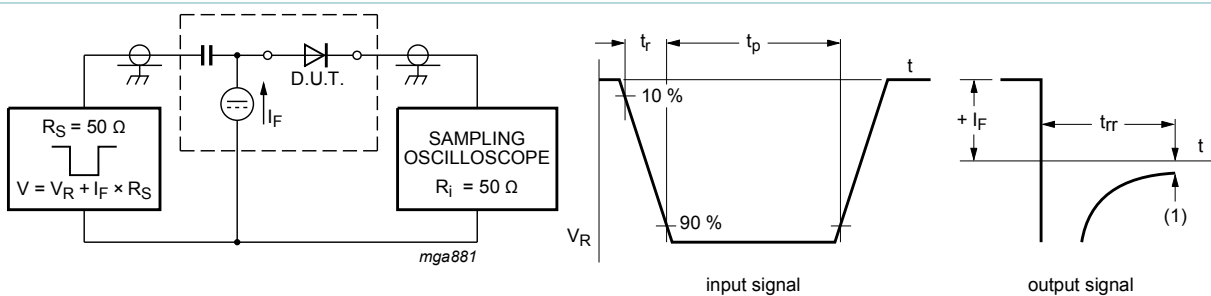


Based on square wave currents.

$T_{j(\text{init})} = 25 \text{ }^\circ\text{C}$

Fig. 6. Non-repetitive peak forward current as a function of pulse duration; maximum values

11. Test information



(1) $I_R = 1 \text{ mA}$

Fig. 7. Reverse recovery time test circuit and waveforms

Quality information

This product has been qualified in accordance with the Automotive Electronics Council (AEC) standard Q101 - Stress test qualification for discrete semiconductors, and is suitable for use in automotive applications.

12. Package outline

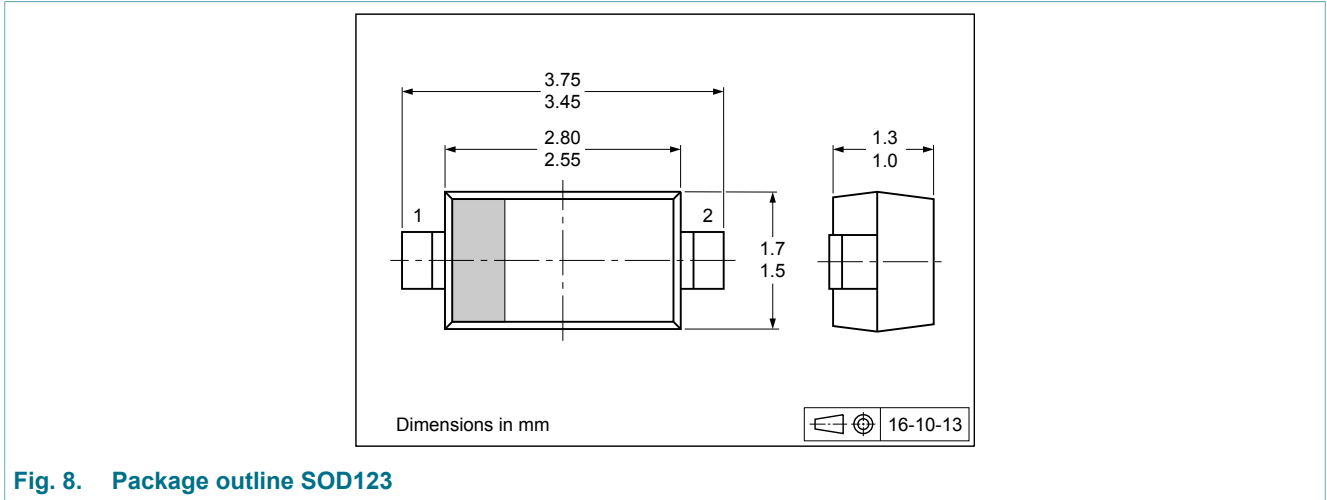


Fig. 8. Package outline SOD123

13. Soldering

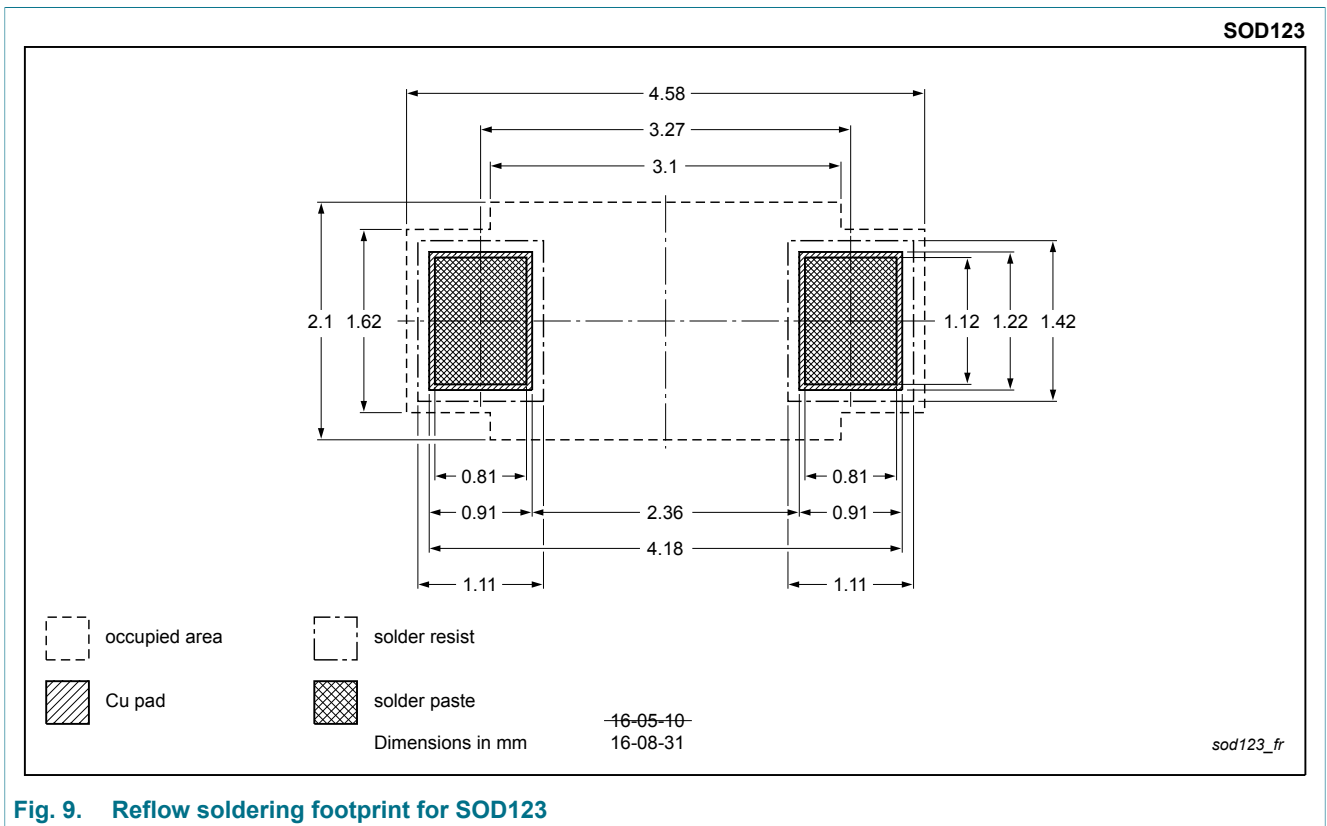


Fig. 9. Reflow soldering footprint for SOD123

SOD123

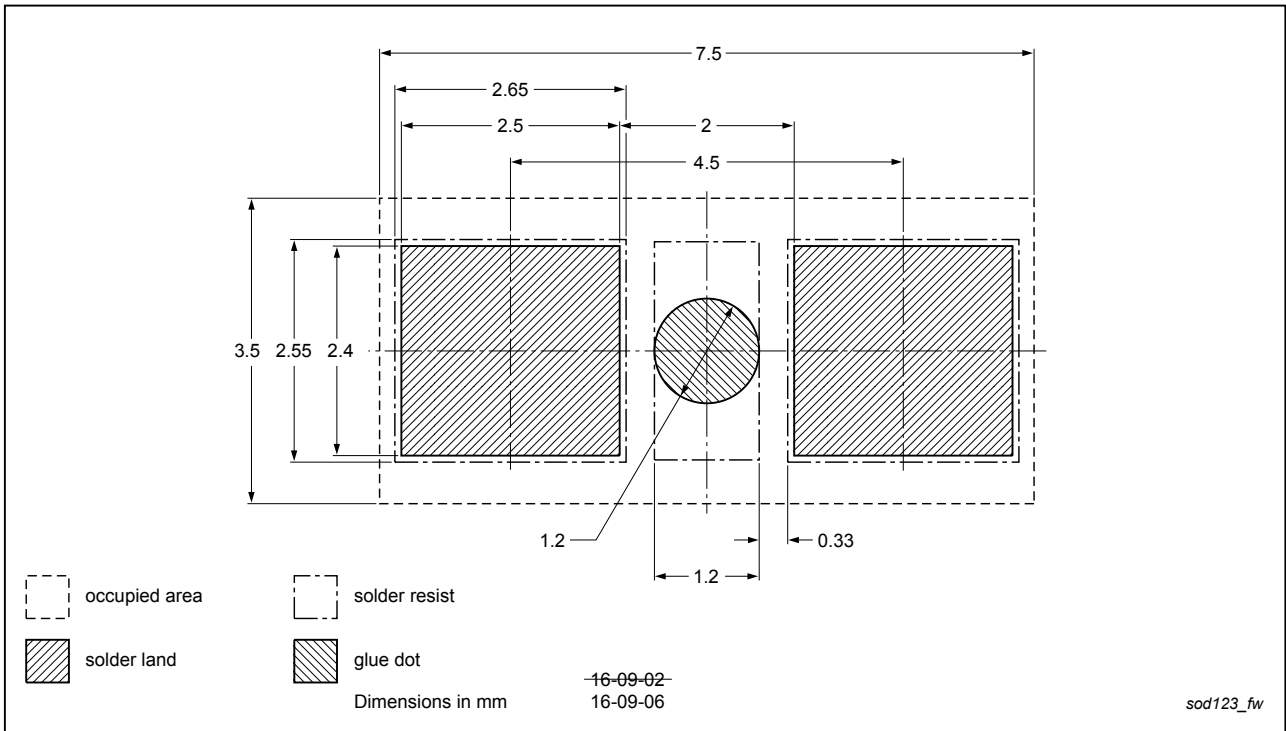


Fig. 10. Wave soldering footprint for SOD123

14. Revision history

Table 8. Revision history

Data sheet ID	Release date	Data sheet status	Change notice	Supersedes
BAS116GW v.2	20180405	Product data sheet	-	BAS116GW v.1
Modifications:	<ul style="list-style-type: none">Unit corrected to nA in Table 7, reverse current at 150 °C			
BAS116GW v.1	20161124	Product data sheet	-	

15. Legal information

Data sheet status

Document status [1][2]	Product status [3]	Definition
Objective [short] data sheet	Development	This document contains data from the objective specification for product development.
Preliminary [short] data sheet	Qualification	This document contains data from the preliminary specification.
Product [short] data sheet	Production	This document contains the product specification.

- [1] Please consult the most recently issued document before initiating or completing a design.
- [2] The term 'short data sheet' is explained in section "Definitions".
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For sales office addresses, please send an email to: salesaddresses@nexperia.com
Date of release: 5 April 2018
